# **UM11930**

# RD33772C14VEVM 14 V battery management system

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**User manual** 

#### **Document information**

Information	Content
Keywords	14VBMS, MC33772C, S32K344, FS26
Abstract	The RD33772C14VEVM is a reference design for 14 V battery management systems in electric vehicle applications. Targeting to meet ASIL C functional safety level requirements.



## RD33772C14VEVM 14 V battery management system

#### **Revision history**

Rev	Date	Description
1	20230925	initial version

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RD33772C14VEVM 14 V battery management system

# 1 Introduction

This document is the user guide for the RD33772C14VEVM reference design. This document is intended for the engineers involved in the evaluation, design, implementation, and validation of a 14 V battery management system (BMS) in a vehicle. The scope of this document is to provide the user with information to evaluate the features of the 14 V BMS device. This document covers the hardware connection steps, software and tools installation and environment configuration for the kit usage. The RD33772C14VEVM allows the user to connect to a 14 V power supply for voltage sensing, current sensing, temperature sensing and the diagnostic of contactor status.

# 2 Finding kit resources and information on the NXP website

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The information page for RD33772C14VEVM user manual is at <a href="http://www.nxp.com/RD33772C14VEVM">http://www.nxp.com/RD33772C14VEVM</a>. The information page provides overview information, technical and functional specifications, ordering information, documentation, and software. The Getting Started tab provides quick-reference information applicable to using the RD33772C14VEVM user manual, including the downloadable assets.

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# 3 Getting ready

Working with the RD33772C14VEVM requires the kit contents, additional hardware, and a Windows PC workstation with installed software.

#### 3.1 Kit contents

- · Evaluation board in an antistatic bag
- · Several cables
- · Quick start guide

#### 3.2 Additional hardware

In addition to the kit contents, the following hardware is necessary or beneficial when working with this kit.

- Low-voltage power supply 5 V to 14 V with current limit set initially to 1.5 A
- · Current load, 0 A to 500 A
- · Controller area network (CAN) card and cable
- Multilink FX debugger cable

UM11930

## RD33772C14VEVM 14 V battery management system

# 3.3 Minimum system requirements

This reference design requires a Windows PC workstation. The kit requires the following to function properly with the demo software:

• Windows 10, 8 or 7 compatible PC with a USB port

#### 3.4 Software

Installing software is necessary to work with this reference design. All listed software is available on <a href="http://www.nxp.com/RD33772C14VEVM">http://www.nxp.com/RD33772C14VEVM</a>.

• S32 design studio integrated development environment (IDE) for Arm

# 4 Getting to know the hardware

#### 4.1 Kit overview

The RD33772C14VEVM is a hardware tool for evaluation and development. It is ideal for rapid prototyping of a 14 V BMS. This board can be used to evaluate the features of the MC33772C device.

## 4.2 Board features

- Power supply input from 9 V to 18 V
- · Up to 10 channels temperature sensing
- Up to 4 channels pack voltage measurement
- · Redundant current measurement
- External positive temperature coefficient (PTC) for self-heating function of lithium-ion battery
- · Hardware short circuit protection and software (SW) overcurrent protection
- 1 channel CAN and 1 channel local interconnect network (LIN) communication with vehicle control unit (VCU)

## 4.3 Board functions implemented

Table 1. Board functions

Functions	Description
Voltage measurement	cell voltage
	up to 4 channels pack voltage
Current measurement	1 channel by MC33772C
	1 channel by MCU
Temperature measurement	3 channels for cell
	1 channel for metal-oxide-semiconductor field-effect transistor (MOSFET)
	1 channel for shunt resistor
	1 channel for cell balancing
	3 channels reserved
Communication	serial peripheral interface (SPI) (internal)
	1 channel LIN (external)
	1 channel CAN (external)

UM11930

# RD33772C14VEVM 14 V battery management system

Table 1. Board functions...continued

Functions	Description
Load path	2 parallel MOSFETs
	MOSFET diagnostic
	pre-driver
PTC	self-heating for battery cell

## 4.4 Device features

This reference design features the following NXP products:

Table 2. Device features

Device	Description	Features
MC33772C	-	<ul> <li>5.0 V ≤ VPWR ≤ 30 V operation, 40 V transient</li> <li>3 to 6 cells management</li> <li>0.8 mV total cell voltage measurement error</li> <li>Isolated 2.0 Mbit/s differential communication or 4.0 Mbit/s SPI</li> <li>Addressable on initialization</li> <li>Synchronized cell voltage and current measurement with coulomb count</li> <li>Total stack voltage measurement</li> <li>Seven general-purpose input/output (GPIO) or temperature sensor inputs</li> <li>5.0 V reference supply output with 5 mA capability</li> <li>Automatic over/undervoltage and temperature detection routable to fault pin</li> <li>Integrated sleep mode over/undervoltage and temperature monitoring</li> <li>Onboard 300 mA passive cell balancing with diagnostics</li> <li>Hot plug capable</li> <li>Detection of internal and external faults, as open lines, shorts, and leakages</li> <li>Designed to support ISO 26262 up to automotive safety integrity level (ASIL) D safety system</li> <li>Fully compatible with the MC33771 for a maximum of 14 cells</li> </ul>
		Qualified in compliance with AEC-Q100

# RD33772C14VEVM 14 V battery management system

Table 2. Device features...continued

Device	Description	Features
S32K344	AEC-Q100 qualified 32-bit Arm Cortex-M7-based MCUs targeted for general purpose automotive and high-reliability industrial applications	<ul> <li>Single, multiple, or lockstep Cortex-M7 cores, 120 MHz to 240 MHz + floating point unit (FPU)</li> <li>512 kB to 8 MB flash with error correcting code (ECC)</li> <li>Firmware over-the-air (FOTA): A/B firmware swap with zero downtime and roll-back support; automatic address translation</li> <li>12-bit 1 Msps analog-to-digital converter (ADC), 16-bit enhanced modular input/output system (eMIOS) timer with logic control unit for motor control</li> <li>Low-power Run and Standby modes, fast wake-up, clock, and power gating</li> <li>-40 °C to +125 °C AEC-Q100</li> <li>Minimum 15-year longevity</li> <li>Safety, security, and connectivity</li> <li>ISO 26262 up to ASIL B/D</li> <li>Fault collection and control unit</li> <li>Hardware and software watchdogs, clock/power/temperature monitors</li> <li>Safety documentation and SafeAssure community support</li> <li>Hardware security engine (HSE) security engine - AES-128/192/256, Rivest, Shamir, and Adleman public key cryptosystem (RSA), ECC, secure boot, and key storage; side channel protection; ISO 21434 intended</li> <li>Ethernet TSN/AVB (10/100 Mbit/s), I3C, controller area network flexible data rate (CAN FD), flexible input/output (FlexIO) (SPI/IIC/IIS/SENT protocol), serial audio interface (SAI), quadruple serial peripheral interface (QSPI)</li> </ul>
FS26	safety system basis chip (SBC) with low power fit for ASIL D	<ul> <li>Input supply up to 40 V DC</li> <li>HV buck, adjustable step down DC-DC converter 3.2 V to 6.35 V (50 mV step), 1.5 A DC</li> <li>VCORE, adjustable step down DC-DC converter 0.8 V to 3.3 V (10 mV step), 800 mA to 1500 mA</li> <li>Boost controller 5.5 V to 17 V, external switch</li> <li>LDO1 and LDO2, configurable 3.3 V or 5.0 V, up to 300 mA DC output current capability</li> <li>Voltage reference (VREF), accurate voltage reference 3.3 V or 5 V, 1 %, 30 mA DC output current capability</li> <li>2 trackers, 10 mV offset, 125 mA DC output current capability</li> <li>32 bits SPI [including cyclic redundancy check (CRC)]</li> <li>Long duration timer (with dedicated part number)</li> <li>Third-generation fail-safe state machine with independent safety monitoring unit</li> <li>Target &lt; 25 μA in Low-power mode in LPOFF and &lt; 50 μA in Standby (MCU powered)</li> <li>AMUX: battery, internal safety critical voltages, precise reference voltage and temperature, GPIOs</li> <li>GPIO: wake-up or HS/LS driver</li> </ul>

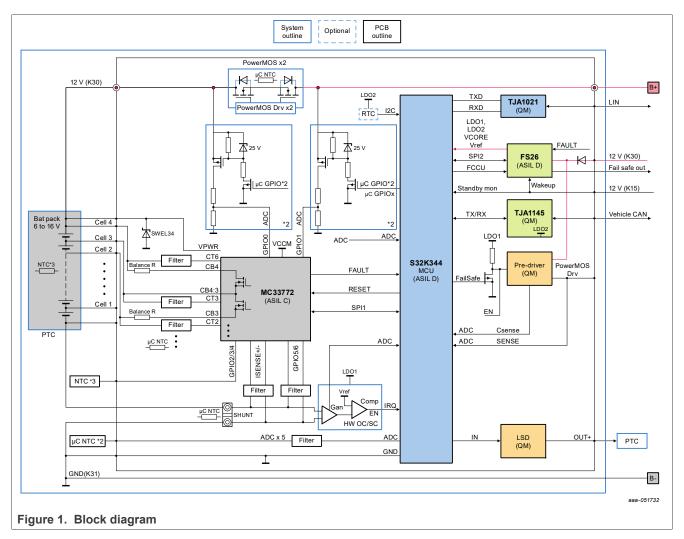
# RD33772C14VEVM 14 V battery management system

Table 2. Device features...continued

Device	Description	Features
TJA1021	LIN2.1/Society of Automotive Engineers (SAE) J2602 transceiver	<ul> <li>LIN 2.1/SAE J2602 compliant</li> <li>Baud rate up to 20 kBd</li> <li>Very low electromagnetic emission (EME)</li> <li>High electromagnetic immunity (EMI)</li> <li>Passive behavior in unpowered state</li> <li>Input levels compatible with 3.3 V and 5 V devices</li> <li>Integrated termination resistor for LIN follower applications</li> <li>Wake-up source recognition (local or remote)</li> <li>K-line compatible</li> <li>Very low current consumption in Sleep mode with local and remote wake-up</li> <li>High electrostatic discharge (ESD) robustness: ±6 kV according to IEC 61000-4-2 for pins LIN, VBAT, and WAKE_N</li> <li>Transmit data (TXD) dominant time-out function</li> <li>Bus terminal and battery pin protected against transients in the automotive environment (ISO 7637)</li> </ul>
TJA1145	high speed CAN transceiver	<ul> <li>ISO 11898-2:2016 and SAE J2284-1 to SAE J2284-5 compliant</li> <li>Data rates up to 5 Mbit/s in the CAN FD fast phase</li> <li>Autonomous bus biasing</li> <li>Fully compatible with the TJA1145, with improved electromagnetic compatibility (EMC) performance</li> <li>±6 kV ESD protection, according to IEC TS 62228 on pins BAT and WAKE and on the CAN bus pins</li> <li>CAN bus pins short-circuit proof to ±58 V</li> <li>Suitable for use in 12 V and 24 V systems</li> <li>AEC-Q100 qualified</li> </ul>

## RD33772C14VEVM 14 V battery management system

# 4.5 Block diagram



## RD33772C14VEVM 14 V battery management system

## 4.6 Connectors

<u>Figure 2</u> shows the location of connectors on the board. <u>Table 3</u>, <u>Table 4</u>, and <u>Table 5</u> list the pinouts for J2, J5, and J6.

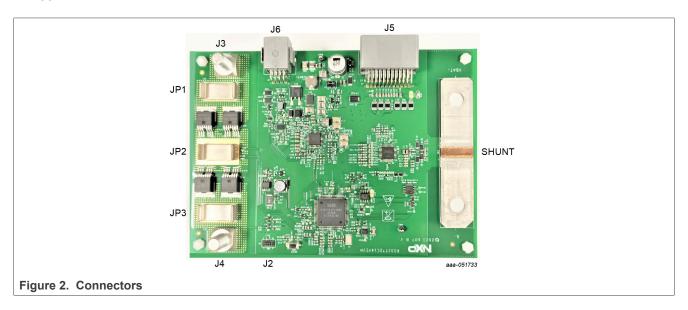


Table 3. Joint Test Access Group (JTAG) connector (J2) description

Pin	Name	Description
1	J2_1	VCC
2	J2_2	JTAG_SWDIO/TMS
3	J2_3	GND
4	J2_4	JTAG_SWDCLK/TCK
5	J2_5	GND
6	J2_6	JTAG_SWO/TDO
7	J2_7	KEY
8	J2_8	JTAG_NC/TDI
9	J2_9	GND_Detect
10	J2_10	JTAG_nRESET

Table 4. J5 connector description

Pin	Name	Description
1	J5_1	K30_12V_L
2	J5_2	K30_12V_L
3	J5_3	K30_12V_L
4	J5_4	CELL_4
5	J5_5	CELL_3

UM11930

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# RD33772C14VEVM 14 V battery management system

Table 4. J5 connector description...continued

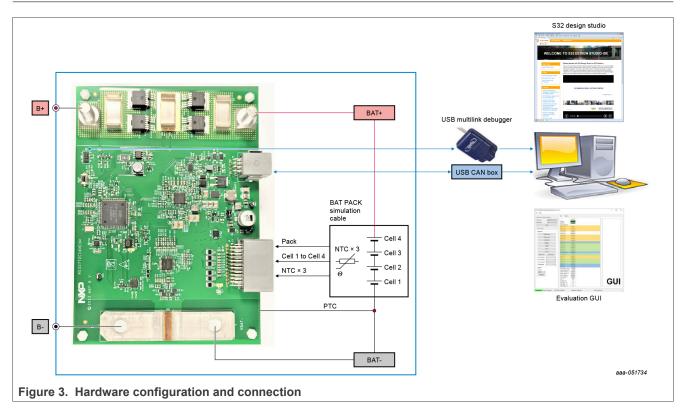
Pin	Name	Description
6	J5_6	CELL_2
7	J5_7	CELL_1
8	J5_8	CELL_0
9	J5_9	GND_KL31_UP
10	J5_10	GND_KL31_UP
11	J5_11	GND_KL31_DOWN
12	J5_12	GND_KL31_DOWN
13	J5_13	BCC_NTCIN_1
14	J5_14	GND
15	J5_15	BCC_NTCIN_2
16	J5_16	GND
17	J5_17	BCC_NTCIN_3
18	J5_18	GND
19	J5_19	MCU_NTCIN_1
20	J5_20	GND
21	J5_21	MCU_NTCIN_2
22	J5_22	GND
23	J5_23	GND_KL31_DOWN
24	J5_24	GND_KL31_DOWN

Table 5. J6 connector description

Pin	Name	Description
1	J6_1	KL15_WAKE
2	J6_2	LSD_OUT
3	J6_3	SBC_FS0B
4	J6_4	SBC_FS1B
5	J6_5	LIN
6	J6_6	GND
7	J6_7	CAN_H
8	J6_8	CAN_L

## RD33772C14VEVM 14 V battery management system

# 5 Configuring the hardware



The RD33772C14VEVM is used in a standalone configuration. There is no connector to add an expansion board. All required cables are included in the kit.

- For power on the board, need an external 12 V DC power source supply B+ and B-
- Connect the low-voltage connector to J6, the CAN/local interconnect network (LIN) wire communicates with PC with external CAN/LIN tool
- Connect battery simulation cable to J5 and source from 12 V DC
- · Connect the debug tool to J2 for software purpose

## 6 References

- [1] MC33772C product summary page <a href="http://www.nxp.com/MC33772C">http://www.nxp.com/MC33772C</a>
- [2] S32K344 product summary page <a href="http://nxp.com/s32k3">http://nxp.com/s32k3</a>
- [3] FS26 product summary page http://nxp.com/fs26

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UM11930

## RD33772C14VEVM 14 V battery management system

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# RD33772C14VEVM 14 V battery management system

# **Contents**

1	Introduction	3
2	Finding kit resources and information on	
	the NXP website	3
2.1	Collaborate in the NXP community	
3	Getting ready	3
3.1	Kit contents	3
3.2	Additional hardware	3
3.3	Minimum system requirements	4
3.4	Software	4
4	Getting to know the hardware	4
4.1	Kit overview	4
4.2	Board features	4
4.3	Board functions implemented	4
4.4	Device features	
4.5	Block diagram	8
4.6	Connectors	9
5	Configuring the hardware	11
6	References	11
7	Legal information	12

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